

# **CMOS vertex detector for TESLA**

## **Particle Tracking Using CMOS**

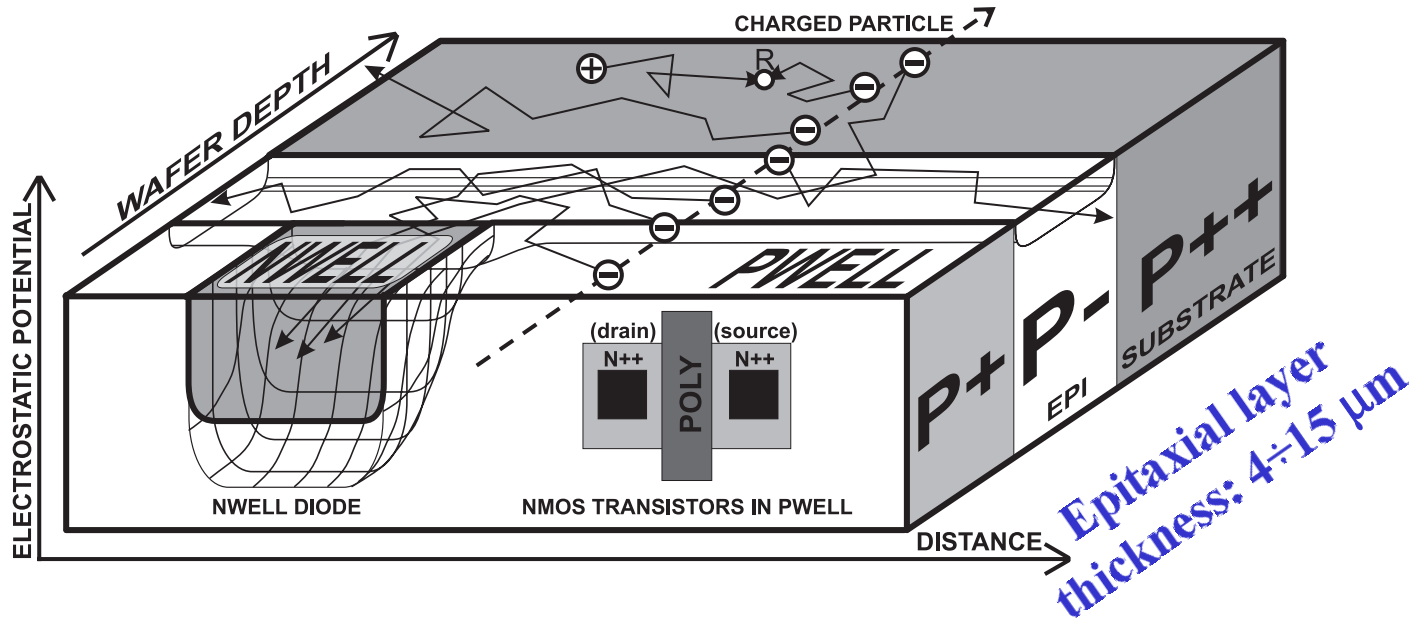
### **Monolithic Active Pixel Sensor**

**G.Claus, C.Colledani, G.Deptuch, W.Dulinski, Yu.Gornushkin,  
Y.Hu, D.Husson, R.Turchetta, J.L.Riester and M.Winter**  
**IReS and LEPSI, Strasbourg, France**

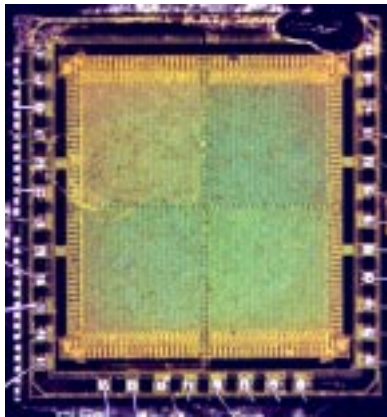
## **Contents**

- Idea and basic architecture of a CMOS MAPS**
  - Prototype MIMOSA chips**
    - Charge collection : timing and efficiency**
    - High energy particles beam test results :  
S/N, efficiency, spatial resolution**
  - Conclusion and Future Development Prospects**

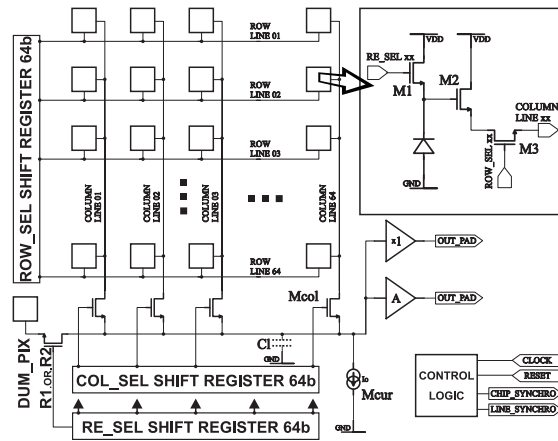
**Cross-section of a CMOS twin-tub wafer with a charge collecting structure allowing 100% *Fill Factor*, essential for tracking application**



**Advantages of a standard (submicron) CMOS :**  
**availability, reasonable cost, radiation hardness,**  
**feasibility of a “system on a chip” solution**



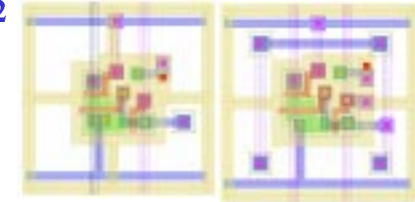
MIMOSA I die photo



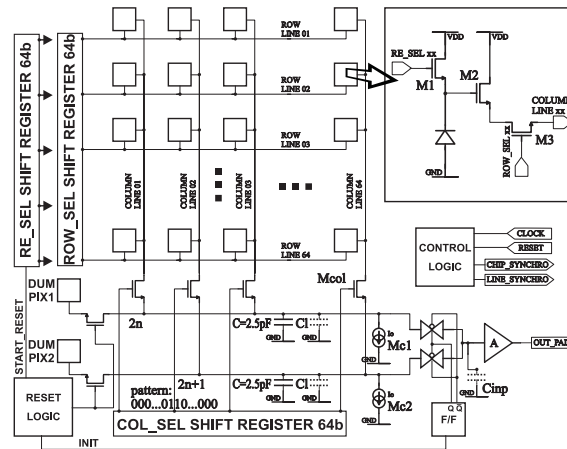
MIMOSA I block schematic diagram

- standard 0.6µm CMOS ( $t_{ox}=12.7\text{nm}$ )
- 14µm thick EPI layer ( $10^{14}\text{cm}^{-3}$ )
- 4 arrays 64x64 pixels
- pixel pitch  $20\times 20\mu\text{m}^2$
- diode (nwell/p-epi) size  $3\times 3\mu\text{m}^2 - 3.1\text{fF}$
- serial analogue readout
- max. clock freq.: 5MHz
- die size  $3.6\times 4.2\text{mm}^2$
- technology 3M+2P
- power supply 5V

MIMOSA I  
pixels layouts



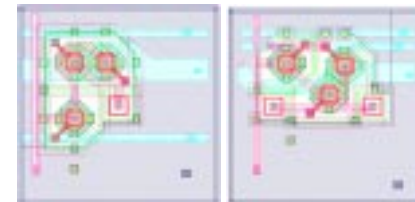
MIMOSA II die photo



MIMOSA II block schematic diagram

- standard 0.35µm CMOS ( $t_{ox}=7.4\text{nm}$ )
- 4.2µm thick EPI layer ( $10^{15}\text{cm}^{-3}$ )
- 6 arrays 64x64 pixels
- pixel pitch  $20\times 20\mu\text{m}^2$
- diode (nwell/p-epi) size  $1.7\times 1.7\mu\text{m}^2 - 1.65\text{fF}$
- serial analogue readout
- max. clock freq.: 25MHz
- die size  $4.9\times 3.5\text{mm}^2$
- technology 5M+2P
- power supply 3.3V
- radiation tolerant
- transistor design

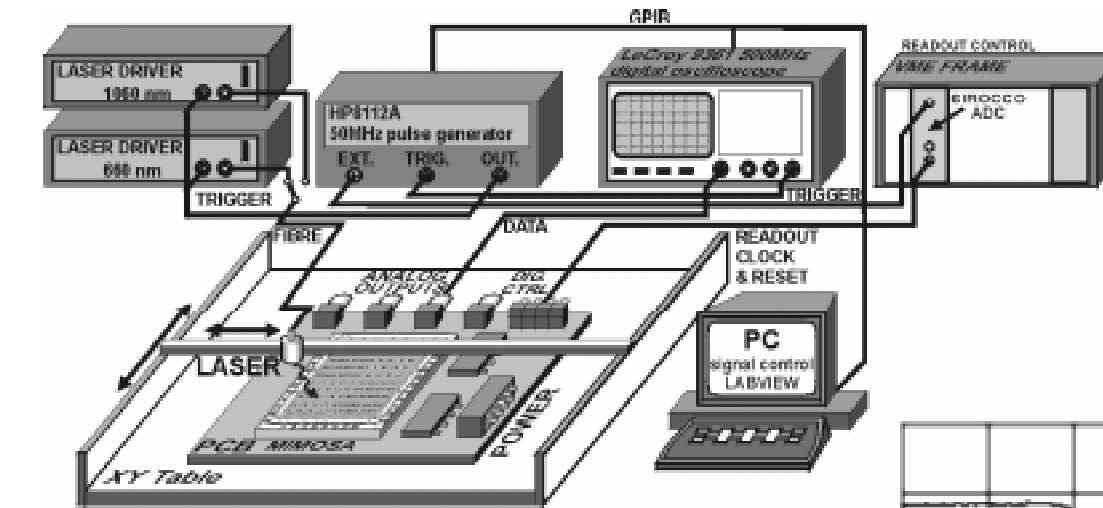
MIMOSA II  
pixels layouts



### Mimosa\* I and Mimosa\* II single cell electronics and readout architecture

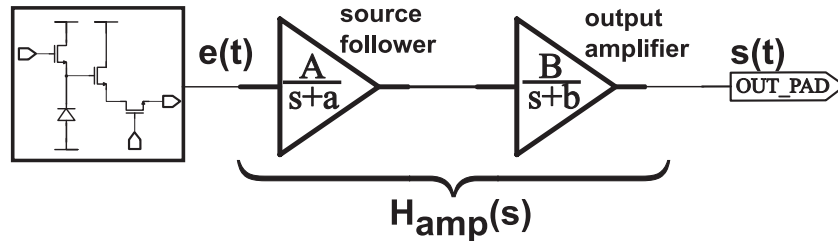
\*Minimum Ionising Particles MOS Active Pixel Sensor

## Charge collection timing properties : tests using visible and IR laser pulse ( $\Delta t < 10\text{ns}$ )



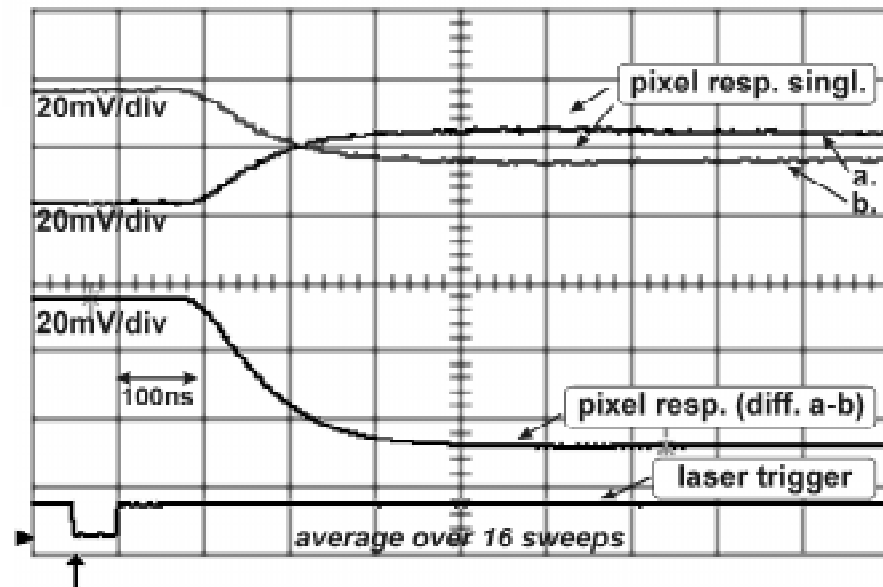
### Use of laser diodes :

- 660nm and 1060nm
- rise time = 0.2ns
- pulse width = 8.5ns
- spot size =  $10\mu\text{m}$  (FWHM)
- delay after trigger = 65ns

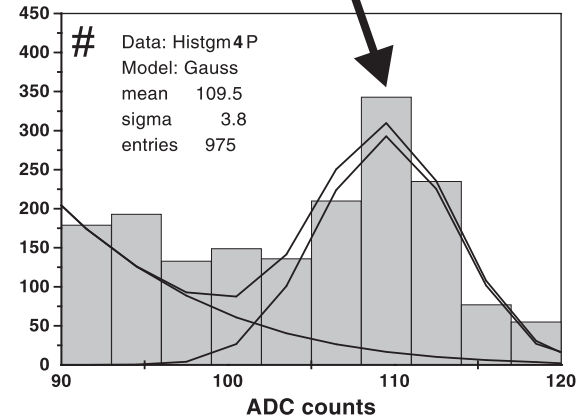
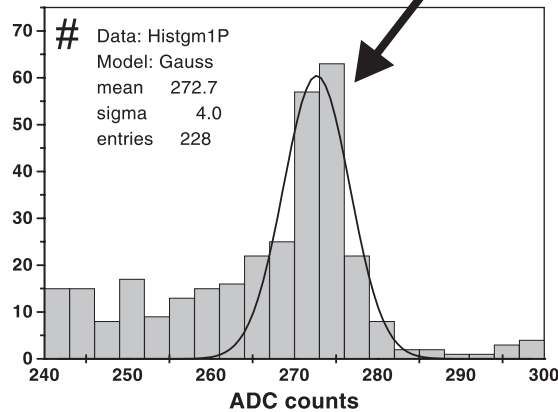
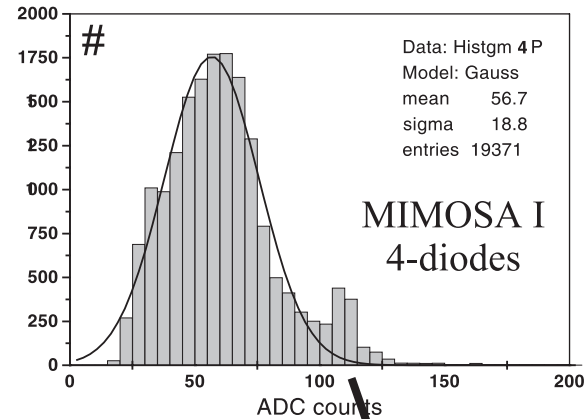
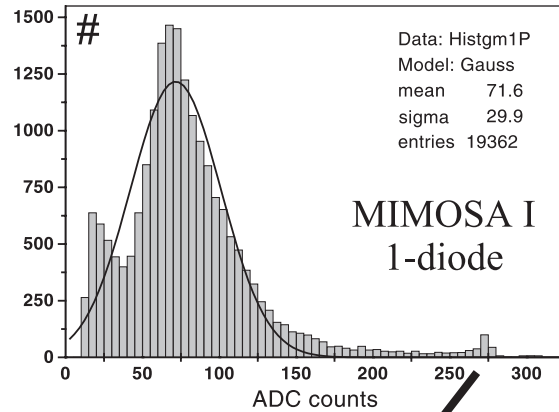


$$e(t) = \frac{1}{A \cdot B} \left[ \frac{d^2 s(t)}{dt^2} + (a + b) \frac{ds(t)}{dt} + a \cdot b \cdot s(t) \right]$$

Equation is solved for  $e(t)$  using discrete differentiation of the measured signal

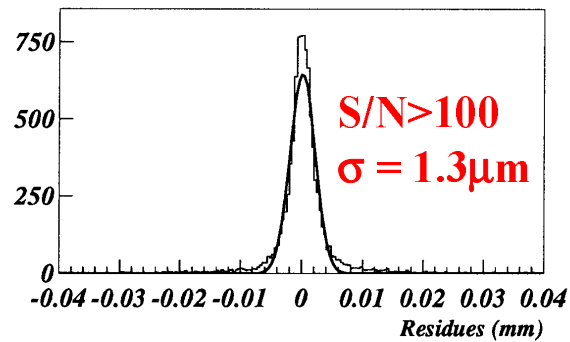
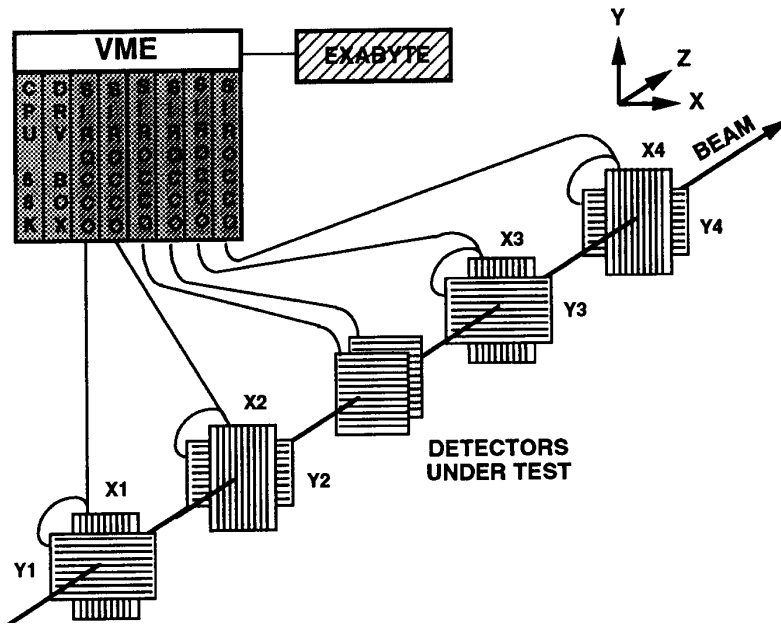


## Gain calibration using soft X-rays (5.9 keV from $^{55}\text{Fe}$ )

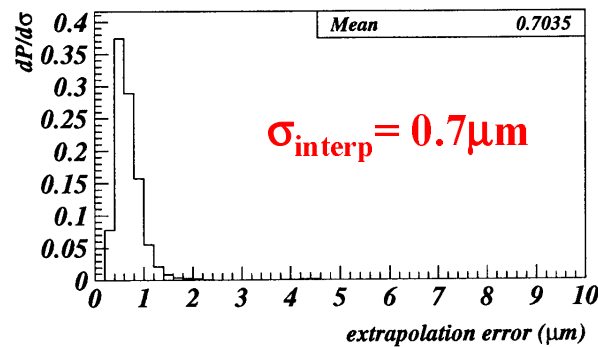


- According to MC simulation the “big peak” doesn’t correspond with 100% of charge collection efficiency !!!
- Taking second peak position (conversion in a depletion region of the collecting diode)...

## Particle tracking tests using 120 GeV/c pions and high precision beam telescope



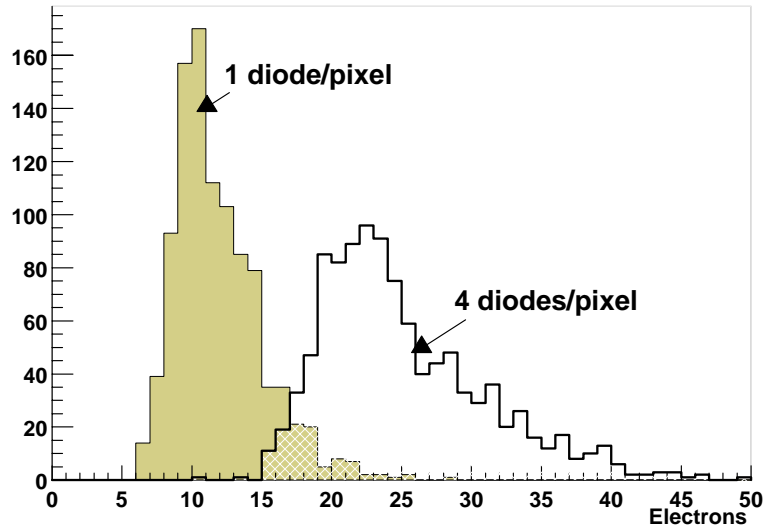
Single plane resolution



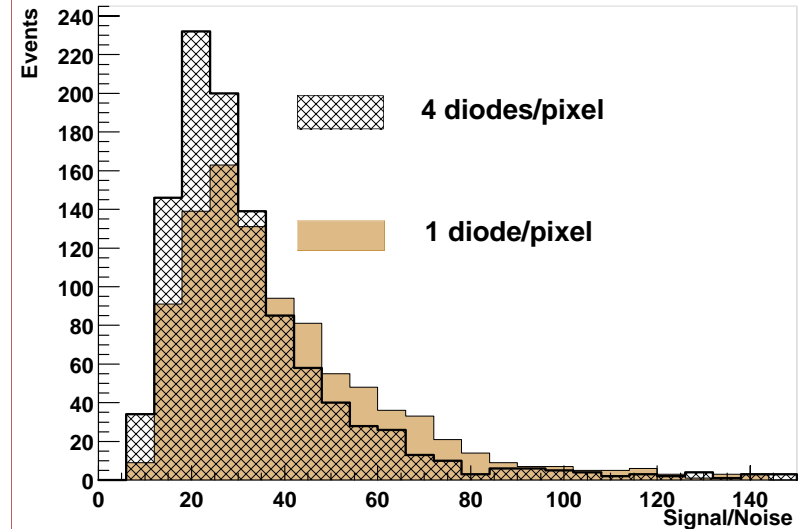
Track position resolution  
in the middle of telescope

## Tracking tests using 120 GeV/c pions

Seed pixel noise for real track cluster



Signal/noise in 1 pixels



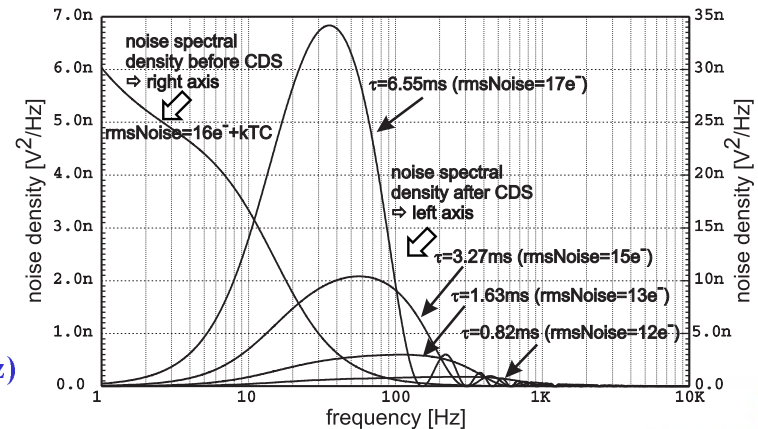
**Noise : 12 e- (1 diode), 25 e- (4 diodes)**

**S/N (central pixel)**

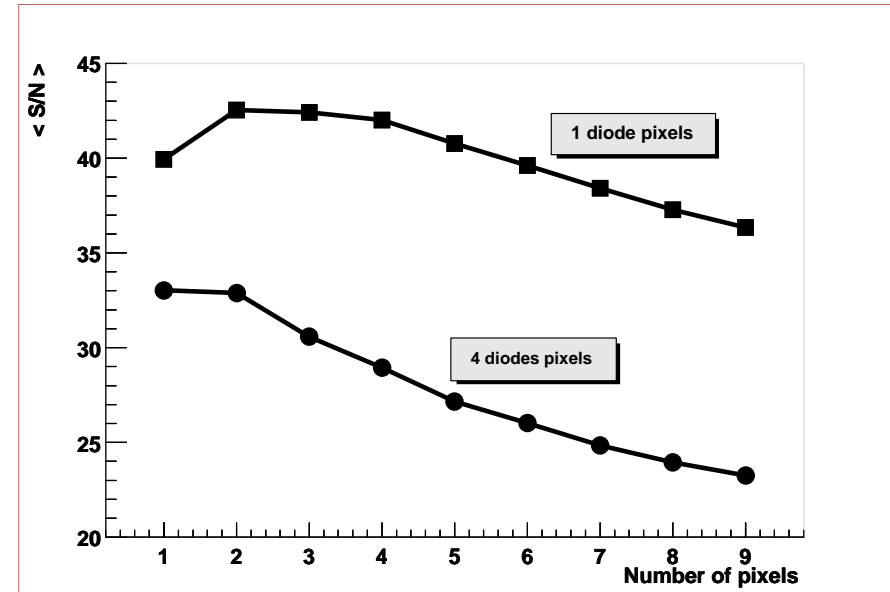
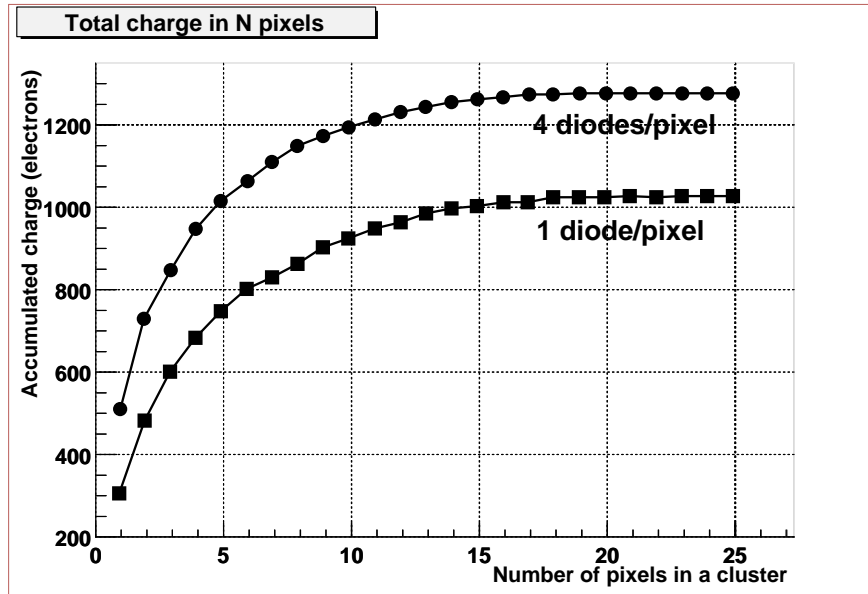
**Analog (Serial) Readout using  
Correlated Double Sampling (CDS)**

**Goal : suppression of both kTC Noise and  
Fixed Pattern (Noise)**

**Noise power spectral density for MIMOSA I  
for sampling frequencies of 0.625, 1.25, 2.5, 5 MHz)**



## Tracking tests using 120 GeV/c pions

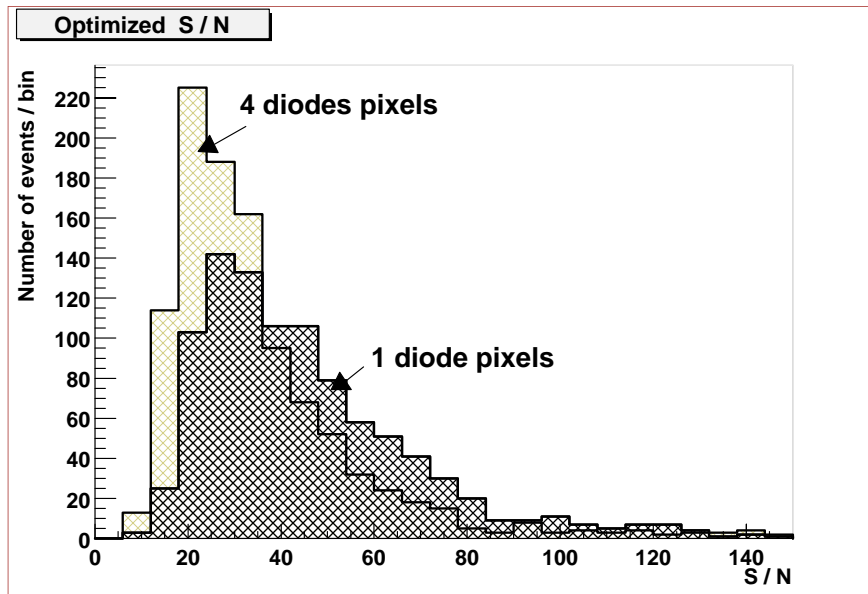


Charge vs. cluster size

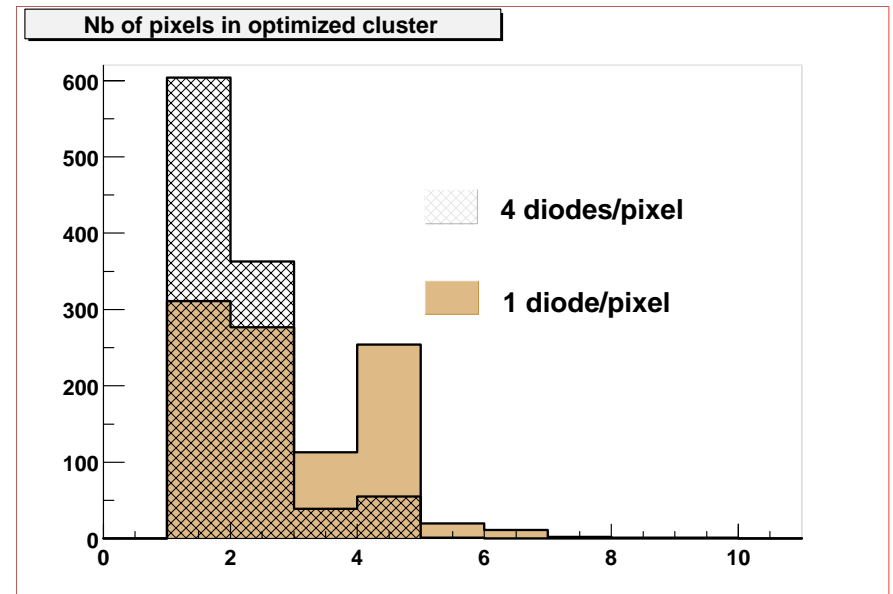
S/N vs. cluster size



## Tracking tests : S/N event-to-event optimisation

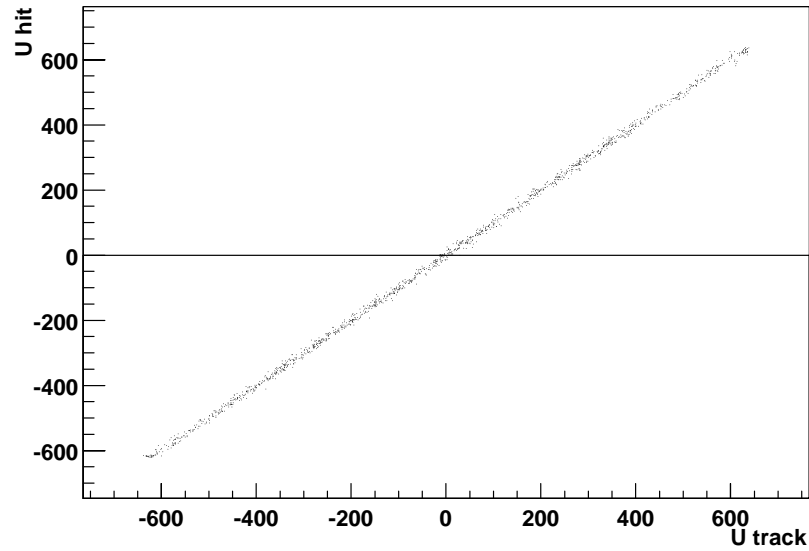


Optimised S/N



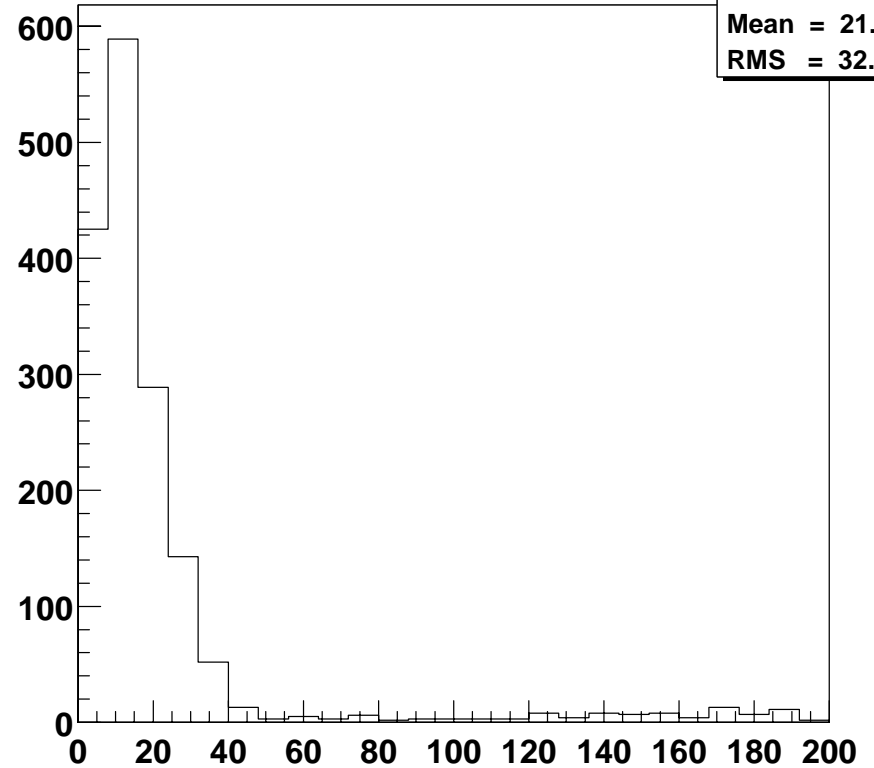
Optimised cluster multiplicity

## Tracking tests : reconstruction efficiency



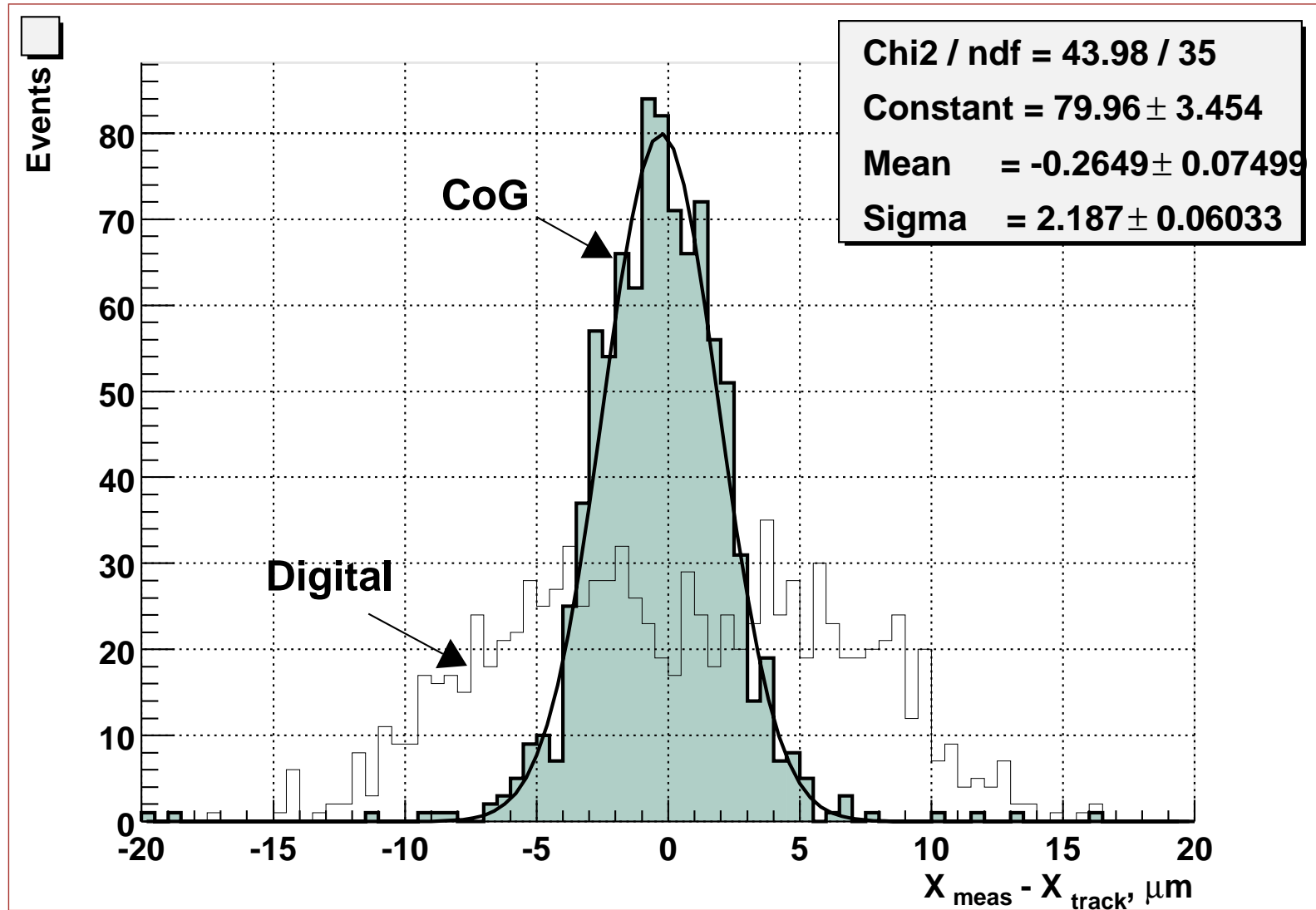
**MAPS - telescope  
hit correlation**

**Delta UV tous clusters**

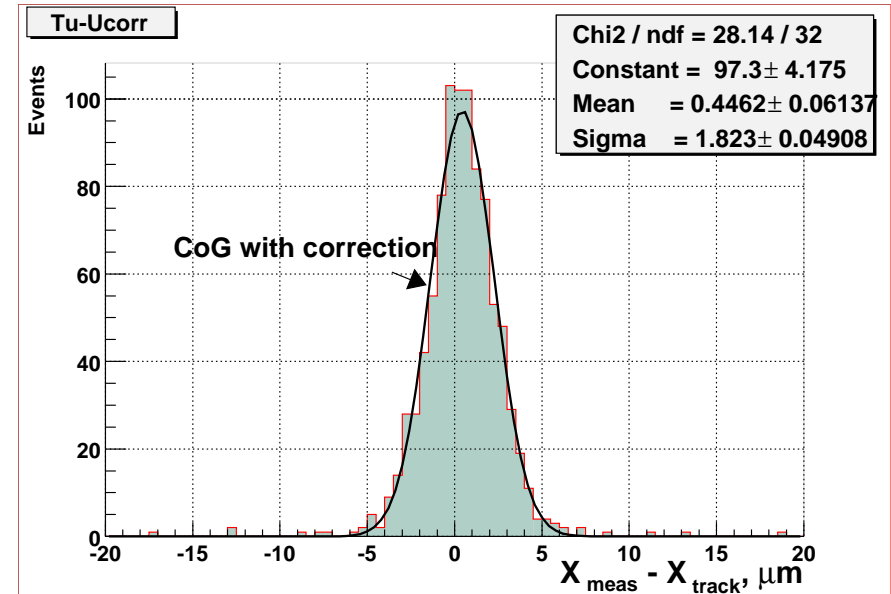
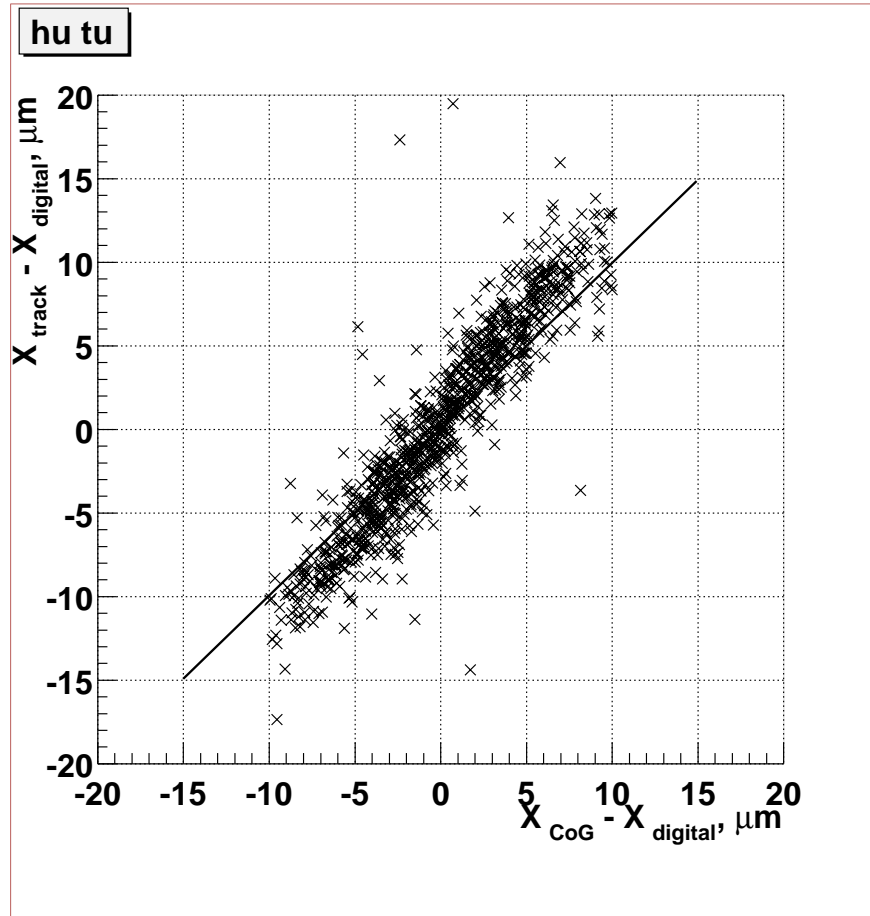


$$\epsilon_{\text{hits} < 50 \mu\text{m}} = 99.5 \pm 0.2 \%$$

## Tracking tests : spatial resolution



## Spatial resolution : optimisation



$\sigma = 1.6 \mu\text{m}$  (preliminary)

## Conclusion and prospects

- **Prototype CMOS Monolithic Active Pixel Sensor works as a minimum ionising particles detector!**
- **Charge collection : reasonably fast ( $\sim 100\text{ns}$ ), spread limited to few pixels, good agreement between device simulation and measurements, NO effects of magnetic field (up to 8 Tesla, both directions)**
- **High energy particles beam test results :**
  - $S/N > 30$ , 100% detection efficiency, spatial resolution :  $< 1.6 \mu$**
- **Rad-tolerant device (Mimosa II,  $0.35 \mu\text{m}$  CMOS) : tracking performance similar to the  $0.6 \mu\text{m}$  prototype, radiation hardness tests soon**
- **Short term future : large area ( $\sim 10 \text{ cm}^2$ ) device ( $\sim$ mid 2001)**
- **Long term future : intelligent, high precision, ultimately thin, large area and low cost device.**